

MOSFET

OptiMOS[™] 6 Power-Transistor, 135 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- 100% avalanche tested
- 175°C operating temperature
- Optimized for motor drives and battery powered applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

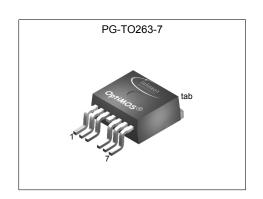
- MSL 1 classified according to J-STD-020

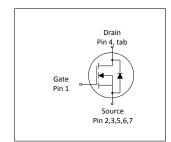


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

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Parameter	Value	Unit					
$V_{ m DS}$	135	V					
R _{DS(on),max}	3.1	mΩ					
I _D	207	A					
Qoss	180	nC					
Q _G (0V10V)	104	nC					
Q _{rr} (500A/µs)	118	nC					











Type / Ordering Code	Package	Marking	Related Links
IPF031N13NM6	PG-TO263-7	031N13N6	-

OptiMOS[™] 6 Power-Transistor, 135 V



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OptiMOS[™] 6 Power-Transistor, 135 V **IPF031N13NM6**



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	Sumb al		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - - -	- - -	207 146 137 23	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =40 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	828	Α	T _C =25 °C	
Avalanche current, single pulse4)	I _{AS}	-	-	90	Α	T _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	435	mJ	I_D =56 A, R_{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	294 3.8	W	T _C =25 °C T _A =25 °C, R _{THJA} =40 °C/W ²⁾	
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol				Unit	Note / Test Condition
raiailietei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.5	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™] 6 Power-Transistor, 135 V IPF031N13NM6



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

D	Corrects of		Value	s		N / / T / O I''
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	135	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.5	3.0	3.5	V	V _{DS} =V _{GS} , I _D =180 μA
Zero gate voltage drain current	I _{DSS}	-	1 10	10 100	μΑ	V _{DS} =108 V, V _{GS} =0 V, T _j =25 °C V _{DS} =108 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	- - -	2.5 2.7 2.9	3.0 3.1 3.5	mΩ	V _{GS} =15 V, I _D =90 A V _{GS} =10 V, I _D =90 A V _{GS} =8 V, I _D =45 A
Gate resistance ¹⁾	R _G	-	1.0	1.5	Ω	-
Transconductance ¹⁾	g fs	90	180	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 90 A$

Table 5 **Dynamic characteristics**

Damamatan	Ol	Values			11	Nata / Tank Oam distant
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	7100	9200	pF	V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	1400	1800	pF	V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	20	35	pF	V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz
Turn-on delay time	t _{d(on)}	-	21	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =45 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	19	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =45 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	t _{d(off)}	-	35	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =45 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	15	-	ns	$V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =45 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Cumb al		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge ¹⁾	Q _{gs}	-	32	42	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =45 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	Q _{g(th)}	-	21	-	nC	V_{DD} =68 V, I_{D} =45 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q_{gd}	-	20	30	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =45 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	31	-	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =45 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	104	135	nC	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =45 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	4.5	-	V	$V_{\rm DD}$ =68 V, $I_{\rm D}$ =45 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	95	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	180	234	nC	V _{DS} =68 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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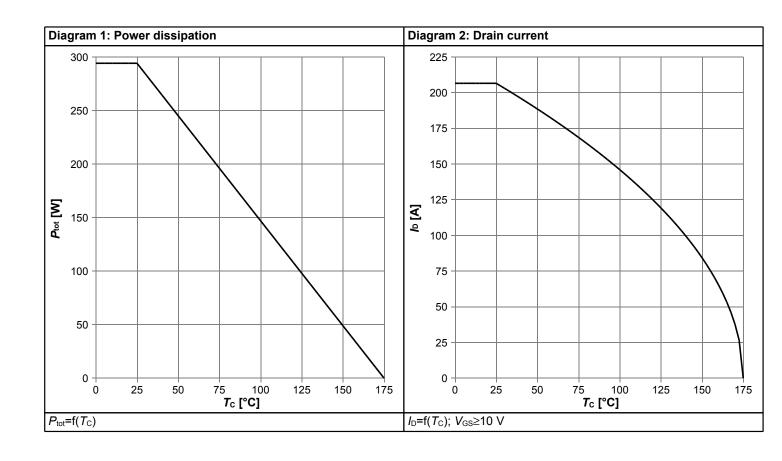


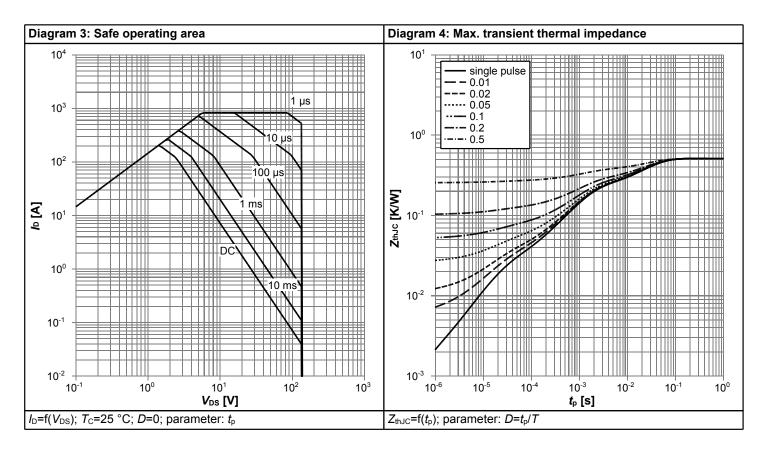
Table 7 Reverse diode

Parameter	Symbol		Values			Nata / Tast Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	I _S	-	-	207	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	828	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.87	1	V	V _{GS} =0 V, I _F =90 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	32	64	ns	V _R =68 V, I _F =45 A, di _F /dt=500 A/μs
Reverse recovery charge ¹⁾	Qrr	-	118	236	nC	V_{R} =68 V, I_{F} =45 A, di_{F}/dt =500 A/ μ s

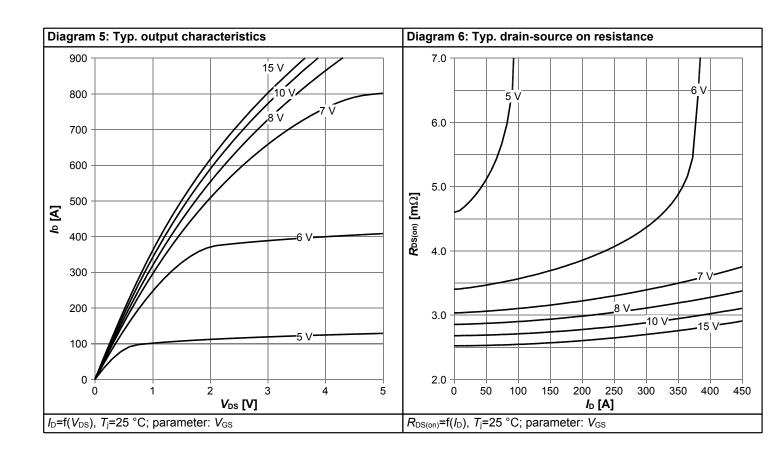


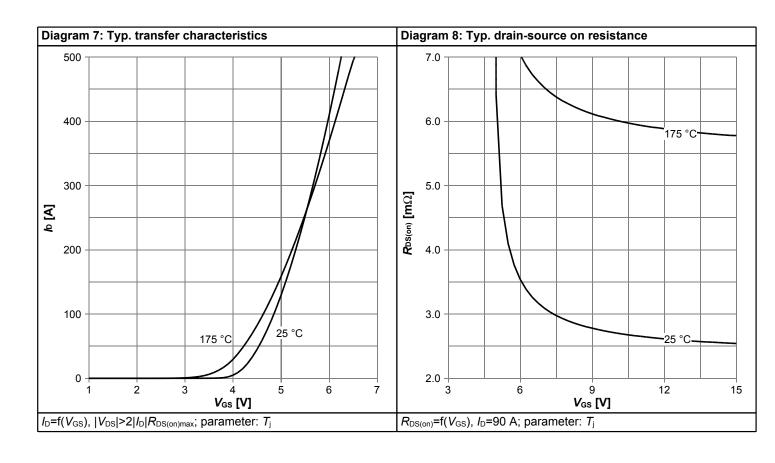
4 Electrical characteristics diagrams



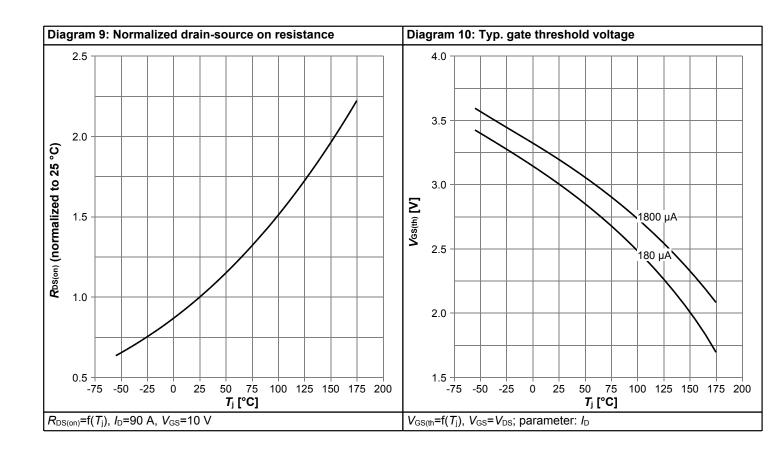


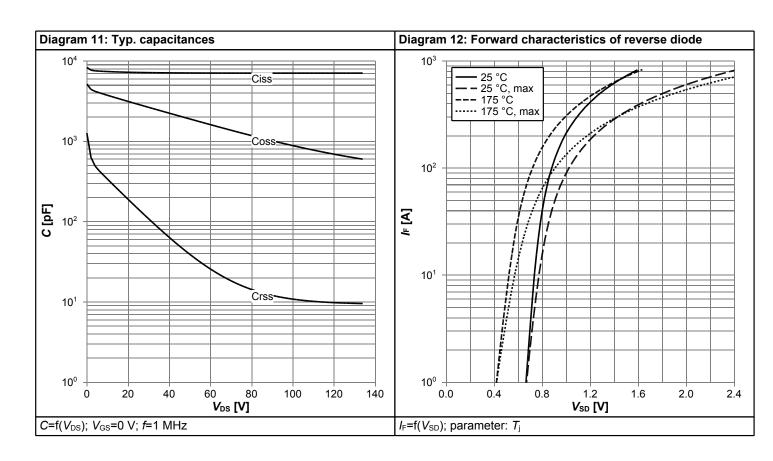




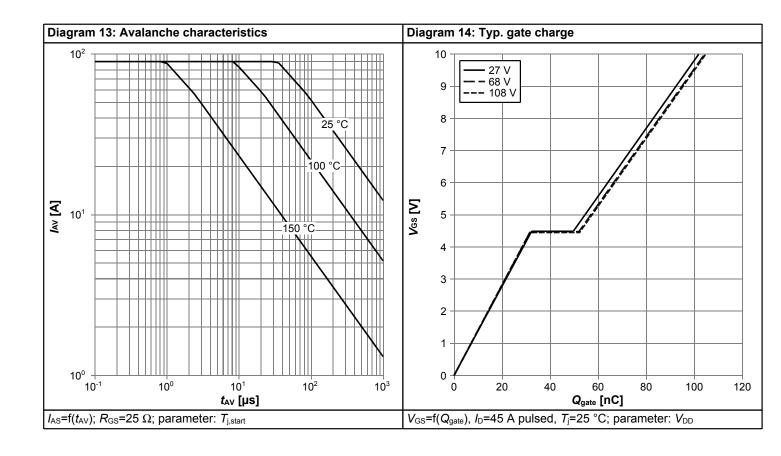


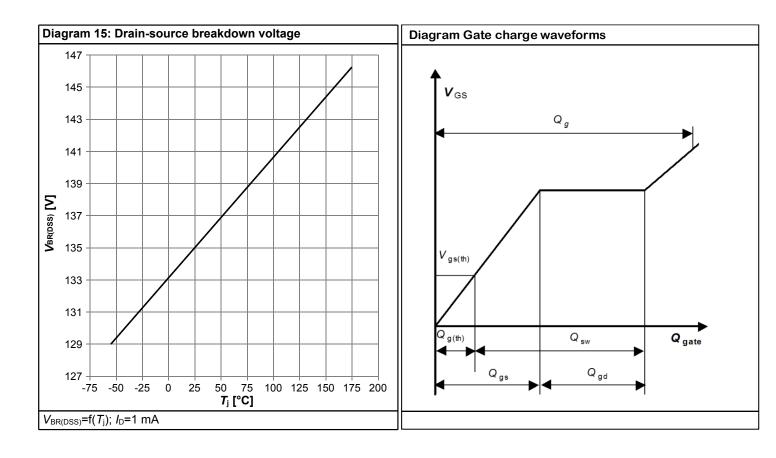






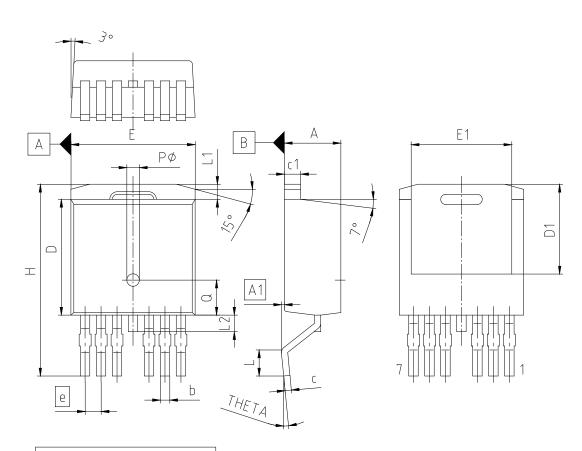








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TO263-7-U02					
DIMENSIONS	MILLIN	METERS				
DIMENSIONS	MIN.	MAX.				
Α	4.30	4.70				
A1	0.00	0.25				
b	0.65	0.85				
С	0.45	0.60				
c1	1.25	1.40				
D	9.00	9.40				
D1	6.86	7.42				
E	9.68	10.08				
E1	7.70	8.30				
е	1.	27				
N	7					
Н	14.61	15.88				
L	1.78	2.79				
L1	0.00	1.60				
L2	0.00	1.78				
THETA	0° - 8°					
PØ	0.90 1.10					
Q	2.78					

Figure 1 Outline PG-TO263-7, dimensions in mm

OptiMOSTM 6 Power-Transistor, 135 V IPF031N13NM6



Revision History

IPF031N13NM6

Revision: 2023-10-16, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2023-10-16	Release of final version			

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